



Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C		
	16mΩ @ V _{GS} = -4.5V	-9.1A		
	21.5mΩ @ V _{GS} = -2.5V	-7.9A		
-12V	26mΩ @ V _{GS} = -1.8V	-7.0A		
	32mΩ @ V _{GS} = -1.5V	-6.3A		

Description

This MOSFET is designed specifically for use in battery management applications.

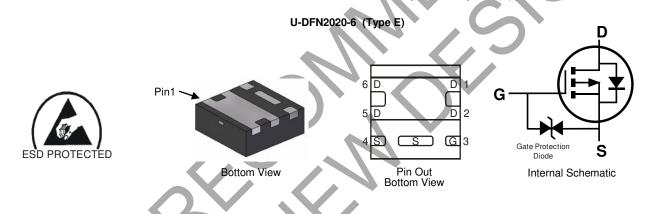
12V P-CHANNEL ENHANCEMENT MODE MOSFET

Features

- 0.6mm Profile Ideal For Low Profile Applications •
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected to 3KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMP1022UFDEQ)

Mechanical Data

- Case: U-DFN2020-6 (Type E)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.0065 grams (Approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Quantity Per Reel
DMP1022UFDE-7	P4	7	3,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

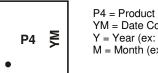
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and 1000ppm antimony compounds.

For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



P4 = Product Type Marking Code YM = Date Code Marking

- Y = Year (ex: E = 2017)
- M = Month (ex: 9 = September)

Date Code Key												
Year	2011	~	2015	2010	6 20 ⁻	17 20	018 2	2019	2020	2021	2022	2023
Code	Y	~	С	D	E		F	G	Н		J	K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-12	V		
Gate-Source Voltage		V _{GSS}	±8	V	
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-9.1 -7.2	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<5s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-11.2 -9.0	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		IDM	-90	А	
Continuous Source-Drain Diode Current	$T_{A} = +25^{\circ}C$ $T_{C} = +25^{\circ}C$	I _S	-2.5 -7.1	А	
Pulsed Source-Drain Diode Current (10µs Pulse, Du	I _{SM}	-50	А		

Thermal Characteristics

		<u> </u>	
	Symbol	Value	Unit
$T_{A} = +25^{\circ}C$ $T_{A} = +70^{\circ}C$	PD	0.66	w
Steady State t<5s	Reja	189 123	°C/W
$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	PD	2.03 1.3	W
Steady State t<5s	R _{0JA}	61 40	°C/W
Steady State	R _{ejc}	9.3	
	T _J , T _{STG}	-55 to +150	°C
	$T_A = +70^{\circ}C$ Steady State t<5s $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ Steady State t<5s	$\begin{tabular}{ c c c c c }\hline $T_A = +25^\circ C$ & P_D \\\hline $T_A = +70^\circ C$ & P_D \\\hline \hline $Steady State$ & $R_{\theta JA}$ \\\hline $T_A = +25^\circ C$ & P_D \\\hline $T_A = +70^\circ C$ & P_D \\\hline \hline $T_A = +70^\circ C$ & P_D \\\hline \hline $Steady State$ & $R_{\theta JA}$ \\\hline \hline $t<5s$ & $R_{\theta JA}$ \\\hline \hline $Steady State$ & $R_{\theta JG}$ \\\hline \hline $Steady State$ & $R_{\theta JG}$ \\\hline \end{tabular}$	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1-inch square copper plate.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	V _{GS} = 0V, I _D = -250µA	
Zero Gate Voltage Drain Current ($T_J = +25^{\circ}C$)	I _{DSS}	_	—	-200	nA	$V_{DS} = -12V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current ($T_J = +55^{\circ}C$) (Note 8)	IDSS	_	—	-2	μA	$V_{DS} = -12V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±2	μΑ	$V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.35	_	-0.8	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
V _{GS(TH)} Temperature Coefficient	$\Delta V_{GS(TH)} / \Delta T_J$	_	2.5	—	mV/°C	I _D = -250μΑ	
On-State Drain Current	I _{D(ON)}	-10	—	_	A	V _{GS} = -4.5V, V _{DS} < -5A	
	\$ <i>1</i>		12	16		V _{GS} = -4.5V, I _D = -8.2A	
			15	21.5		V _{GS} = -2.5V, I _D = -7.2A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	20	26	mΩ	V _{GS} = -1.8V, I _D = -6.6A	
	- (-)		23	32		V _{GS} = -1.5V, I _D = -1A	
			80	160		V _{GS} = -1.2V, I _D = -1A	
Forward Transfer Admittance	Y _{fs}	_	12		S	$V_{DS} = -4V, I_{D} = -8.2A$	
Diode Forward Voltage	V _{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -8A$	
DYNAMIC CHARACTERISTICS (Note 8)	00				v		
Input Capacitance	Ciss	—	2,953	—			
Output Capacitance	Coss		756	—	pF	$V_{DS} = -4V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss		678				
Gate Resistance	R _q	+	8.6	18	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Q	—	28.4	42.6		$V_{GS} = -5V, V_{DS} = -4V, I_D = -10A$	
Total Gate Charge	Q _a		25.3	38			
Gate-Source Charge	Q _{qs}		2.3		nC	$V_{GS} = -4.5V, V_{DS} = -4V,$	
Gate-Drain Charge	Q _{gd}	<u> </u>	7.2	—		I _D = -10A	
Turn-On Delay Time	t _{D(ON)}	—	20	30			
Turn-On Rise Time	tR	/	28	42		$V_{DS} = -4V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	117	176	ns	$R_{G} = 1\Omega, R_{L} = 0.4\Omega, I_{D} = -9.8A$	
Turn-Off Fall Time	tr	—	93	139			
BODY DIODE CHARACTERISTICS					•		
Diode Forward Voltage	V _{SD}	H	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -9.8A$	
Osartina and David Dista Osard (Nata O)			_	-2.5	А	$T_A = +25^{\circ}C$	
Continuous Source-Drain Diode Current (Note 6)	Is	—	—	-7.1		$T_{\rm C} = +25^{\circ}{\rm C}$	
Pulse Diode Forward Current (Note 8)	I _{SM}		—	-50			
Body Diode Reverse Recovery Time (Note 8)	t _{RR}	_	28	56			
Reverse Recovery Fall Time	tA	_	10	_	ns		
Reverse Recovery Rise Time	tB	_	18	_	1	I _S = -9.8A, dl/dt = 100A/µs	
Body Diode Reverse Recovery Charge (Note 8)	Q _{RR}		13	26	nC		

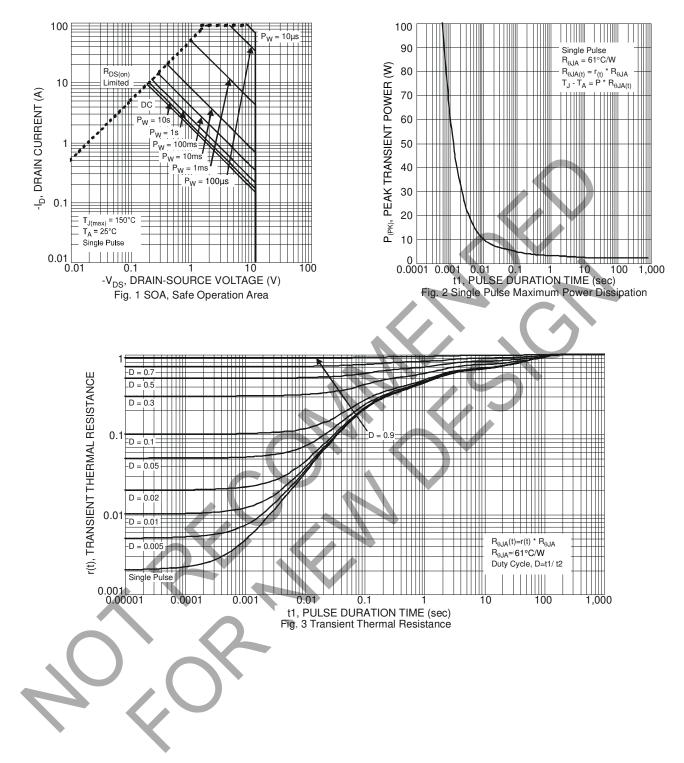
Notes:

Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.



NOT RECOMMENDED FOR NEW DESIGN USE <u>DMP1005UFDF</u>

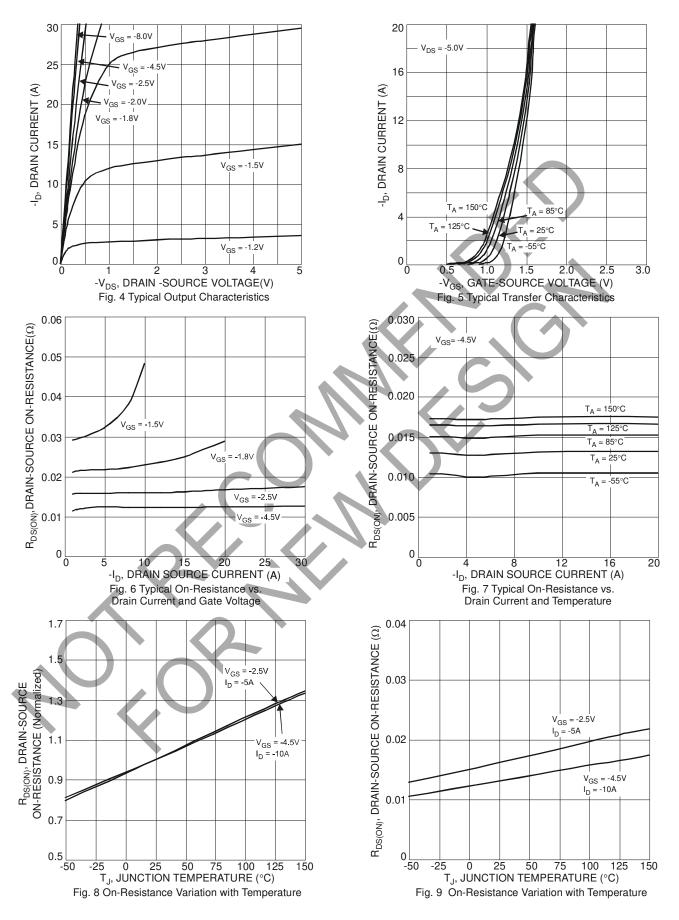
DMP1022UFDE





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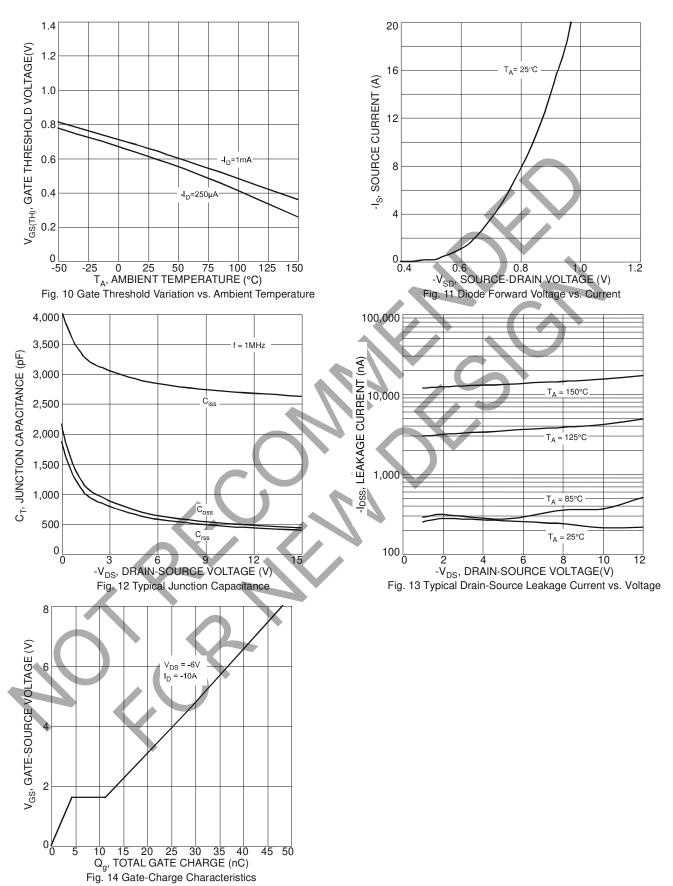
DMP1022UFDE





NOT RECOMMENDED FOR NEW DESIGN USE <u>DMP1005UFDF</u>

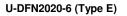
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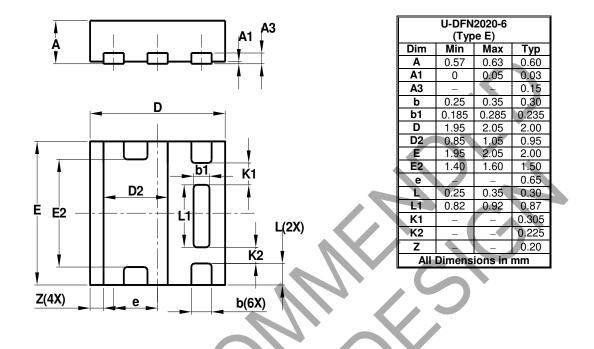




Package Outline Dimensions

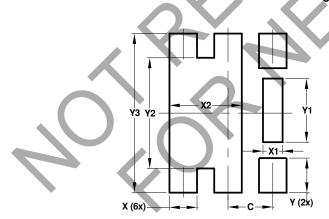
Please see http://www.diodes.com/package-outlines.html for the latest version.





Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



U-DFN2020-6 (Type E)

Dimensions	Value				
Dimensions	(in mm)				
С	0.650				
Х	0.400				
X1	0.285				
X2	1.050				
Y	0.500				
Y1	0.920				
Y2	1.600				
Y3	2.300				



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